



PCB Layout

Pin位	AL	B
2	1.25	4.25
3	2.5	5.5
4	3.75	6.75
5	5	8
6	6.25	9.25
7	7.5	10.5
8	8.75	11.75
9	10	13
10	11.25	14.25
11	12.5	15.5
12	13.75	16.75
13	15	18
14	16.25	19.25
15	17.5	20.5
16	18.75	21.75

SPECIFICATION

1.Material:
Housing: HIGH-TEMP Plastic,UL94V-0,color: Natural.
Contacts: Copper alloy.
Solder tab: Copper alloy.

2.Electrical Characteristics:
Current rating: 1A(max).
Voltage rating: 200V(max).
Operating Temperature: -25°C~+85°C.
Insulation resistance: 1000M ohms min. at 1000V DC
Dielectric withstanding voltage: 1000V AC/minute.
Contact resistance: 30m ohms max.

UNITS: mm		CSCONN		CSCONN PRECISE ELECTRONICS CO.,LTD	
GENERAL TOLERANCE		PART NO.(INTENDED USE)		TITLE:	
X. ° ±5°	0.X±0.25	CWF-125XX-D80		WAFER 1.25MM XP DIP180	
X.1±2°	0.XX±0.2	APPD:		DWG NO.	
XX. ±1°	0.XXX±0.1	CHKD: Skilia		WAFER	
		DR: Kitty		SCALE	
				1:1	
				SHEET	
				1 OF 1	
				REV	
				A	